



Product Summary

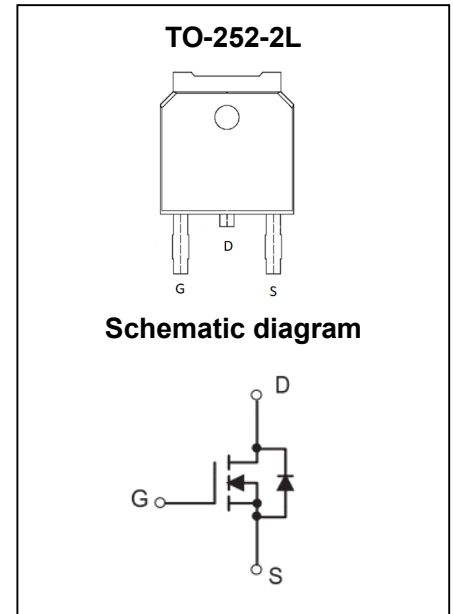
V _{(BR)DSS}	R _{DS(on)TYP}	I _D
30V	6.4mΩ@10V	47A
	7.5mΩ@4.5V	
	12.6mΩ@2.5V	

Feature

- Trench Technology Power MOSFET
- Low R_{DS(ON)}
- Low Gate Charge
- Low Gate Resistance
- 100% UIS Tested

Application

- Power Switching Application



MARKING:



M060N03L = Device Code

XX = Date Code

Solid Dot = Green Indicator

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit	
Drain - Source Voltage	V _{DS}	30	V	
Gate - Source Voltage	V _{GS}	±12	V	
Continuous Drain Current ¹	I _D	T _C = 25°C	47	A
Continuous Drain Current ¹		T _C = 100°C	30	A
Pulsed Drain Current ²	I _{DM}	188	A	
Single Pulsed Avalanche Current ³	I _{AS}	17	A	
Single Pulsed Avalanche Energy ³	E _{AS}	72	mJ	
Power Dissipation ⁵	P _D	T _C = 25°C	28	W
Thermal Resistance from Junction to Case		R _{θJC}	4.4	°C/W
Junction Temperature	T _J	150	°C	
Storage Temperature	T _{STG}	-55~ +150	°C	

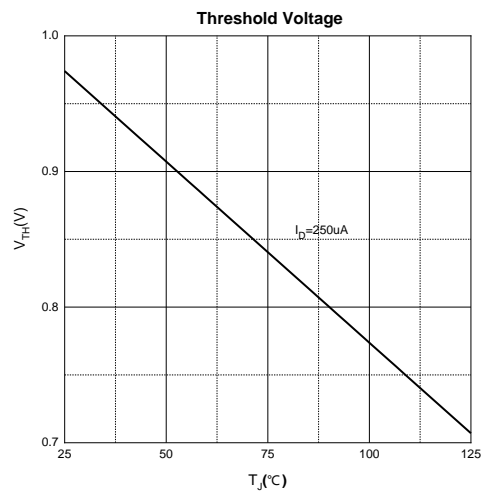
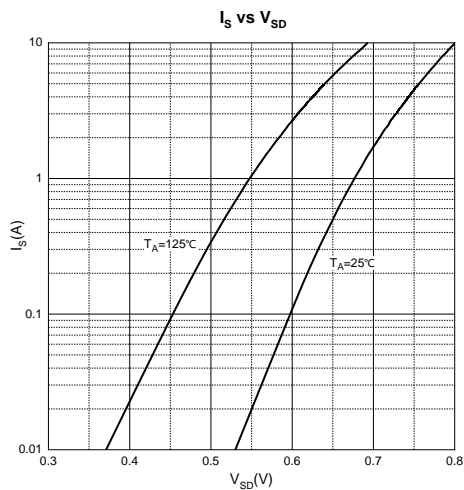
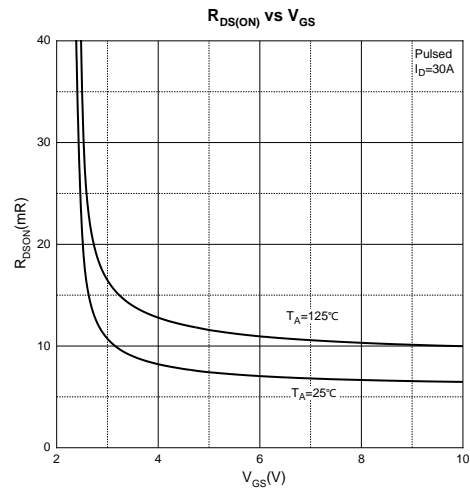
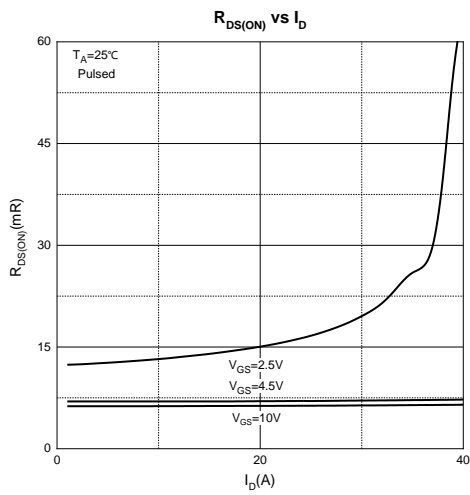
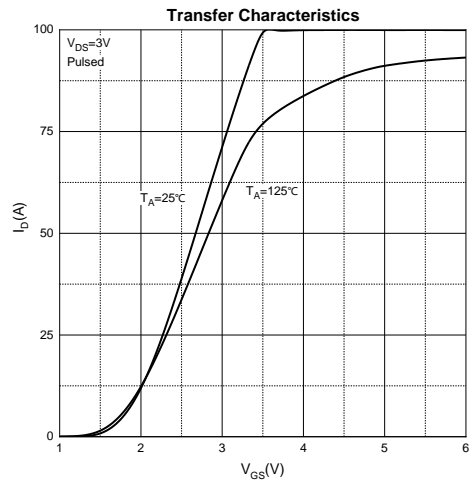
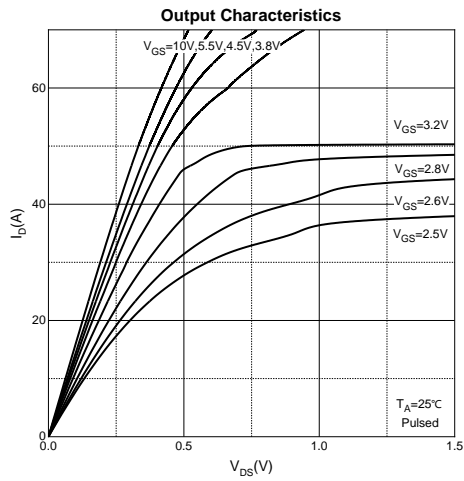
MOSFET ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

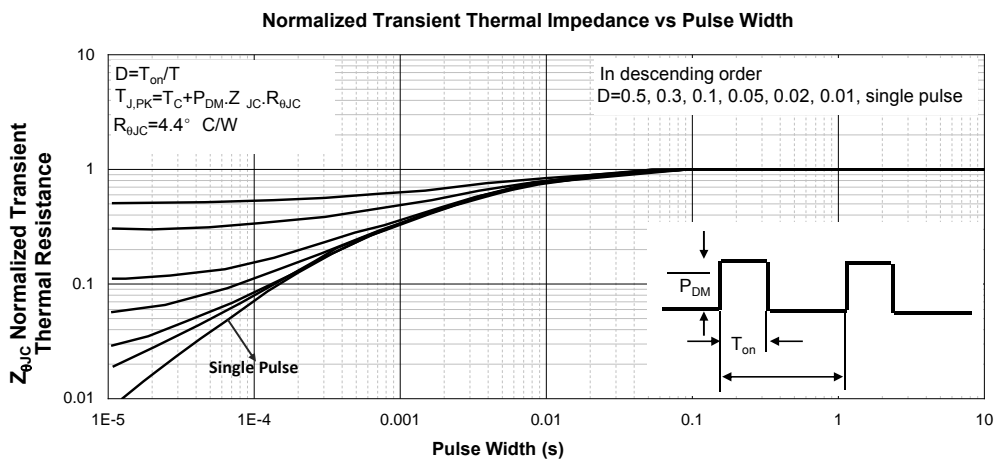
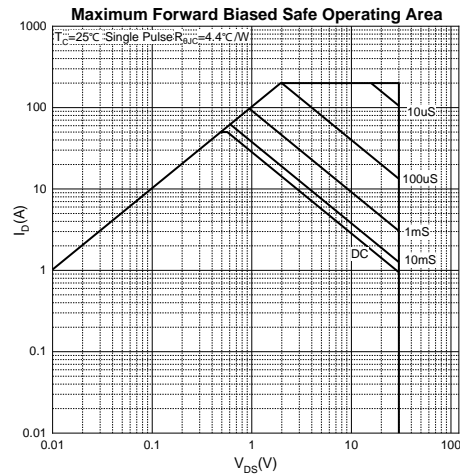
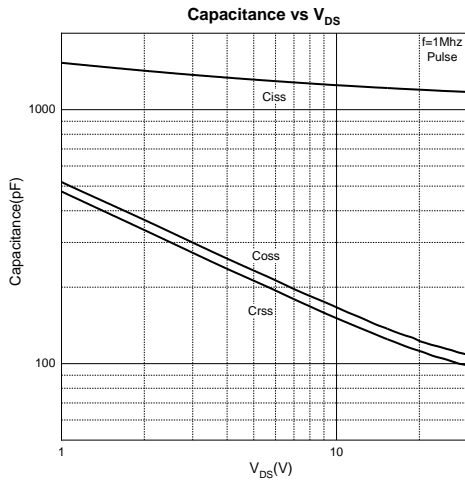
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Off Characteristics						
Drain - Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 24V, V_{GS} = 0V$			1	μA
Gate - Body Leakage Current	I_{GSS}	$V_{GS} = \pm 12V, V_{DS} = 0V$			± 100	nA
On Characteristics⁴						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	0.5	1.0	1.5	V
Drain-source On-resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 10A$		6.4	8	m Ω
		$V_{GS} = 4.5V, I_D = 10A$		7.5	9.5	
		$V_{GS} = 2.5V, I_D = 10A$		12.6	20	
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS} = 15V, V_{GS} = 0V, f = 1MHz$		1205		pF
Output Capacitance	C_{oss}			139		
Reverse Transfer Capacitance	C_{rss}			126		
Gate Resistance	R_g	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$		1.4		Ω
Switching Characteristics						
Total Gate Charge	Q_g	$V_{DS} = 15V, V_{GS} = 10V, I_D = 2A$		30		nC
Gate-source Charge	Q_{gs}			2.0		
Gate-drain Charge	Q_{gd}			5.5		
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = 20V, V_{GS} = 10V, I_D = 2A, R_G = 3\Omega$		7		ns
Turn-on Rise Time	t_r			19		
Turn-off Delay Time	$t_{d(off)}$			24		
Turn-off Fall Time	t_f			24		
Source - Drain Diode Characteristics						
Diode Forward Voltage ⁴	V_{SD}	$V_{GS} = 0V, I_S = 2A$			1.2	V

Notes :

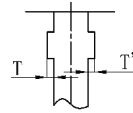
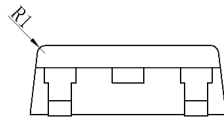
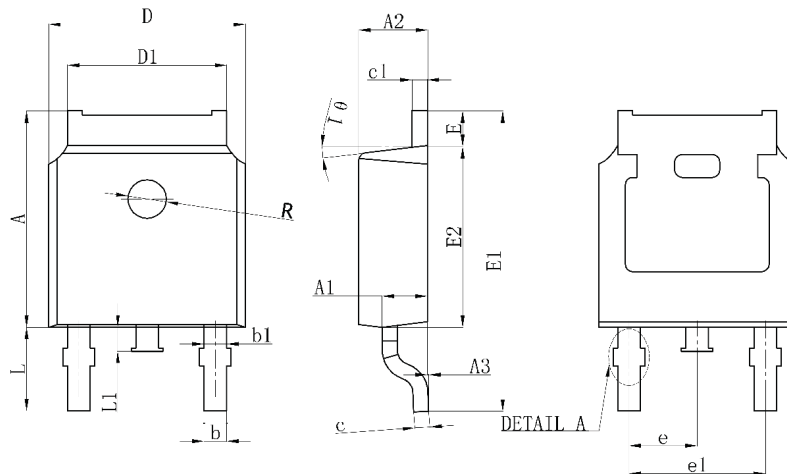
- 1.The maximum current rating is limited by package.And device mounted on a large heatsink
- 2.Pulse Test : Pulse Width $\leq 10\mu s$, duty cycle $\leq 1\%$.
- 3.EAS condition: $V_{DD} = 15V, V_{GS} = 10V, L = 0.5mH, R_G = 25\Omega$ Starting $T_J = 25^\circ\text{C}$.
- 4.Pulse Test : Pulse Width $\leq 300\mu s$, duty cycle $\leq 2\%$.
- 5.The power dissipation P_D is limited by $T_{J(MAX)} = 150^\circ\text{C}$.And device mounted on a large heatsink
- 6.Device mounted on $1in^2$ FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.

Typical Characteristics





TO-252-2L Package Information



$0 < T, T' \leq 0.12$
DETAIL A

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	7.050	7.150	0.278	0.281
A1	0.960	1.060	0.038	0.042
A2	2.200	2.400	0.087	0.094
A3	0.000	0.100	0.000	0.004
b	0.760REF		0.030REF	
b1	1.000REF		0.039REF	
c	0.508REF		0.020REF	
c1	0.508REF		0.020REF	
D	6.550	6.650	0.258	0.262
D1	5.100	5.460	0.201	0.215
E	0.950	1.050	0.037	0.041
E1	9.700	10.400	0.382	0.409
E2	6.000	6.200	0.236	0.244
e	2.286BSC		0.090BSC	
e1	4.572REF		0.180REF	
L	2.650	2.950	0.104	0.116
L1	0.700	0.900	0.028	0.035
θ	7°REF		7°REF	
R	1.300REF		0.051REF	
R1	0.250REF		0.010REF	

单击下面可查看定价，库存，交付和生命周期等信息

[>>GP\(格瑞宝\)](#)